

Travel Grant Application Seattle, WA

The Society's Battery, Corrosion, Dielectric Science & Technology, Electrodeposition, Electronics and Photonics, Energy Technology, High Temperature Materials (HTM), Industrial Electrochemistry and Electrochemical Engineering (IE&EE), Organic and Biological Electrochemistry (OBE), Physical and Analytical Electrochemistry, and Sensor Divisions offer travel grants to students presenting papers at the Society's next meeting, in Seattle, WA, May 6-11, 2012. To apply, complete this application and send it along with a copy of your transcript and a letter from an involved faculty member attesting both to the quality of the student's work and financial needs, and a copy of the student's meeting abstract. For additional information please contact the Division contact below, as requirements might differ among Divisions.

Meeting Site: _____

Name: _____

School Address: _____

Email: _____ Phone #: _____

Undergraduate Year (U) or Graduate Year (G) - circle one: U3 U4 G1 G2 G3 G4 G5

Major Subject: _____ Grade point average: _____ out of possible: _____

(please provide a letter of recommendation from your faculty advisor and a copy of your transcript)

Symposium Title (#): _____

Title of paper to be presented at the meeting: _____

Are you an ECS Student Member of the Society? ☐ yes ☐ no

(if not, please additionally submit the Awarded Student Membership application)

Estimated meeting expenditures: \$ _____

Signature: _____ Date: _____

Check only one Division. (*Applications made to multiple Divisions will be rejected.*)

- ☐ Battery—*Send to:* Christopher S. Johnson, Argonne National Lab, 9700 S. Cass Ave. #CSE-205, Argonne IL 60439-4803, USA, e-mail: johnsoncs@cmt.anl.gov
- ☐ Corrosion—*Send to:* N. Missert, Sandia National Labs, MS 1415, P.O. Box 5800, Albuquerque, NM 87185-0100, USA, e-mail: namisse@sandia.gov
- ☐ Dielectric Science & Technology—*Send to:* Peter Mascher, McMaster University, Engineering Physics Dept., Hamilton, Ontario L8S-4L7, Canada, e-mail: mascher@mcmaster.ca
- ☐ Electrodeposition—*Send to:* Philippe M. Vereecken, IMEC, 3001 Leuven, Kapeldreef 75, Belgium, e-mail: Philippe.Vereecken@imec.be
- ☐ Electronics and Photonics—*Send to:* F. Ren, University of Florida, Dept. of Chem. Engr., Gainesville, FL 32611, USA, e-mail: ren@che.ufl.edu
- ☐ Energy Technology—*Send to:* Vaidyanathan (Ravi) Subramanian, Chemical and Materials Engineering Dept., University of Nevada, Reno, NV 89557, USA, email: raviv@unr.edu
- ☐ HTM—*Send to:* Xiao-Dong Zhou, University of South Carolina, 301 Main St., Columbia, SC 29208, USA, e-mail: xiao-dong.zhou@sc.edu
- ☐ IE&EE—*Send to:* G. Venkat Subramanian, Department of Energy, Environment, and Chemical Engineering, Washington University, St. Louis, MO 63130 USA, e-mail: vsubramanian@seas.wustl.edu
- ☐ OBE—*Send to:* A. Fry, Wesleyan University, Chemistry Dept., 52 Lawn Avenue, Middletown, CT 06459, USA, e-mail: afry@wesleyan.edu
- ☐ Physical and Analytical Electrochemistry—*Send to:* Pawel J. Kulesza, University of Warsaw, Dept. of Chemistry, Krakowskie Przedmiescie 26/28, Warsaw, PL-00-927, Poland, e-mail: pkulesza@chem.uw.edu.pl
- ☐ Sensor—*Send to:* Y-L. Chang, Nanomix, Inc., 5980 Horton Street, Suite 600, Emeryville, CA 94608, USA, e-mail: ychang@nano.com

www.electrochem.org/sponsorship/travel_grants.htm

Applications for Travel Grants for the Seattle, WA meeting must be received no later than November 21, 2011.